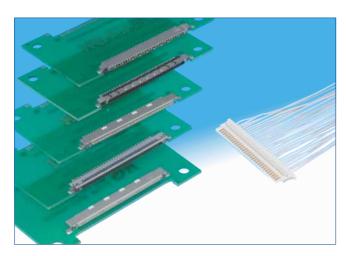
1.0mm Pitch, Board-to-Wire LCD Interface Connectors

MDF76 Series



Features

1. High-speed data transfer

Ground contacts opposite the signal contacts (Receptacle) provide superior impedance matching.

2. EMI protection

Metal shell provides shielding and ground connections.

3. Increased Plug / Receptacle retention force

Unique configuration of the receptacle ground contacts mating with the corresponding plug increases the retention force between them.

4. Incorrect insertion prevention

Built-in polarizing features prevent reverse insertion of the plug in the receptacle.

5. High board retention force

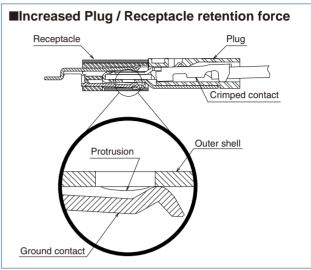
Metal shell is soldered directly to the PC board.

6. RoHS compliant

All components and materials comply with the requirements of EU Directive 2002/95/EC.

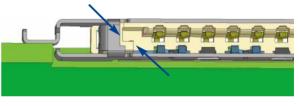
■Applications

Notebook computers, desktop computers, Liquid Crystal Panels, LCD monitors and other devices requiring discrete wire connections with a lowprofile high performance connectors.

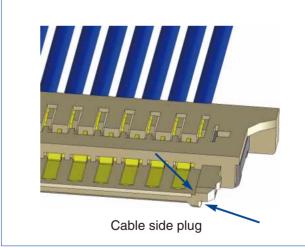


■Incorrect insertion prevention

A vertically asymmetrical key form prevents reverse insertion.



Board side receptacle



■Product Specifications

Ratings	Current rating (Note 1)	Wire size	28 to 30 AWG : 1.0A 32 AWG : 0.8A	Operating temperature range Operating humidity range	-40°C to +85°C (Note 2) RH 20% to 80%
Ratings	(Note 1)	36 AWG : 0.5	36 AWG : 0.5A	Storage temperature range	-10°C to +60°C (Note 3)
	Voltage rating		200V AC	Storage humidity range	RH 40% to 70% (Note 3)

Item	Specification	Conditions
1. Insulation resistance	100MΩ min.	100V DC
2. Withstanding voltage	No flashover or insulation breakdown	500V AC / 1minute
3. Contact resistance	40mΩ max.	20mV max., at 1 mA.
4. Durability	Contact resistance : $80m\Omega$ max. No deformation of components affecting performance.	50 cycles
5. Vibration	No electrical discontinuity of $1\mu s$ or longer No damage, cracks or parts dislocation.	Frequency: 10 to 55Hz, single amplitude of 0.75mm, 10 cycles in each of the 3 axial directions
6. Shock	No electrical discontinuity of $1\mu s$ or longer No damage, cracks or parts dislocation.	Acceleration of 490m/s², 11ms duration, sine half-wave, 3 cycles in each of the 3 axis
7. Humidity	Contact resistance : $80m\Omega$ max., Insulation resistance : $50M\Omega$ min.	96 hours at 60 $\pm 2^{\circ}$ C, and humidity of 90% to 95%
8. Temperature cycle	Contact resistance : $80m\Omega$ max., Insulation resistance : $50M\Omega$ min. No damage, cracks or parts dislocation.	-55°C → 5 to 35 °C → 85 °C → 5 to 35 °C Times : 30 min. → 2 min. to 3 min. → 30 min. → 2min. to 3 min. 5 cycle
9. Resistance to soldering heat	No deformation of components affecting performance.	Reflow : At the recommended temperature profile Manual soldering : 300°C for 3 seconds

Note 1: The current rating will differ depending on the wire size used.

Note 2: Includes temperature rise caused by current flow.

Note 3: The term "storage" refers to products stored for a long period prior to mounting and use.

The operating temperature and humidity range covers the non-conducting condition of connectors after board mounting and the temporary storage conditions of transportation, etc.

■Material / Finish

Plug

Part	Material	Finish	Remarks
Insulator	Polyamide	Color : Beige	UL94V-0
Ground plate	Stainless steel	Tin plated	
Crimp contact	Phosphor bronze	Gold plated	

Receptacle

Part	Material	Finish	Remarks
Insulator	Polyamide	Color : Beige	UL94V-0
Contacts	Phosphor bronze	Gold plated	
Ground contact	Stainless steel	Tin plated	
Shell	Starriess steer	Tin plated	UL94V-0

■Product Number Structure

Refer to the chart below when determining the product specifications from the product number. Please select from the product numbers listed in this catalog when placing orders.

Connector

$$\frac{\mathsf{MDF76}}{\mathbf{0}} \ \frac{\#}{\mathbf{0}} - \frac{*}{\mathbf{6}} \ \frac{\mathsf{P}}{\mathbf{0}} - \frac{1}{\mathbf{6}} \ \frac{\mathsf{C}}{\mathbf{6}}$$

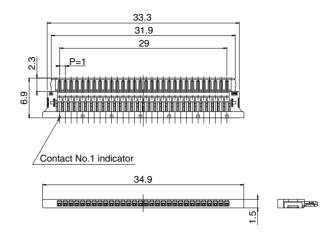
Series Name : MDF76	4 Connector type	
2 Form type	P : Plug	
Plug Blank : Standard	S : Receptalce	
Receptacle (Low profile)	6 Contact pitch : 1mm	
KBW : Standard, mid-mount	6 Housing type	
	C : Crimp	
Number of contacts : 30	H : Right angle SMT	

Contacts

Applicable conductor	3 Plating
2836 : 28 to 36 AWG	A : Gold plated
2 Packaging	
PCF : Male crimp contact / reel	

■Plug (Discrete cable)



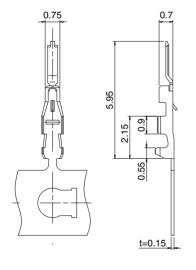


All dimensions: mm

- Shown terminated
- · Supplied in bag. (100 pieces/bag)
- · Contacts supplied separate

Part No.	HRS No.	No. of contacts	Insulator Color
MDF76-30P-1C	547-0918-1	30	Beige

■Crimp contact



Part No.	HRS No.	Packaging	Quantity	Finish
MDF76-2836PCFA(41)	547-0919-4 41	Reel	1 Reel / 30,000	Gold plated

Applicable wire (Tin plated annealed copper wire)

Wire size (Stranded wire conductor)	Jacket diameter
28 AWG (7 / 0.127mm)	
30 AWG (7 / 0.10mm)	0.6mm max.
32 AWG (7 / 0.08mm)	
36 AWG (7 / 0.05mm)	0.4mm max.

Note: When using other than the recommended wire, contact nearest Hirose sales representative.

●Tools

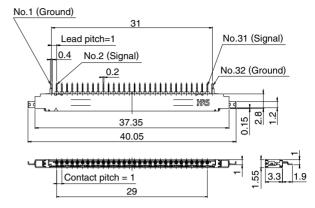
Туре	Part No.	HRS No.
Applicator	AP105-MDF76-2836P	901-4613-1
Press	CM-105C	901-0001-0
Extraction tool	DF-C-PO(B)	550-0179-2

All dimensions : mm

■Receptacles (Low profile)

●Right angle, Standard, mid-mount, SMT





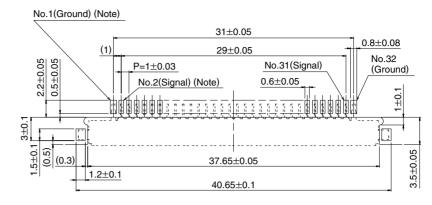
All dimensions : mm

Part No.	HRS No.	No. of contacts	Insulator Color	Packaging	Above the mounting surface
MDF76KBW-30S-1H(55)	547-0606-9 55	30	Beige	3,000 pcs. / reel	1.0mm

■Recommended PCB mounting pattern

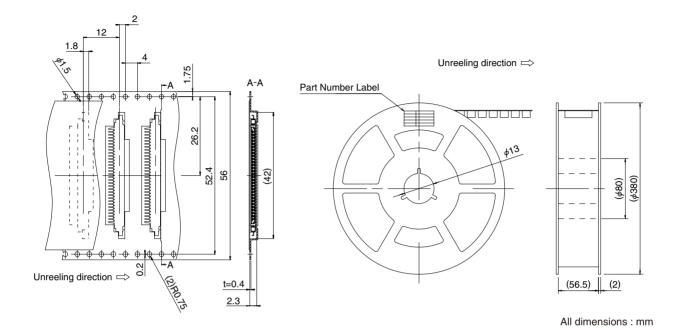
●Mid-mount

For receptacles: MDF76KBW-30S-1H(**)



● Packaging Specifications

◆MDF76KBW-30S-1H(55)



●Usage Recommendations

1.Recommended temperature profile	Temperature (°C) 10sMAX		
	255°CMAX		
	250		
	220°C		
	180°C — 30 to 60sec		
	150		
	60 to 120sec		
	100		
	√		
	Time (Seconds)		
	Note 1 : Up to 2 cycles of Reflow soldering is possible under the same		
	conditions, provided that there is a return to normal temperature between the first and second cycle.		
	Note 2 : The temperature profile indicates the board surface		
	temperature at the point of contacts with the connector terminals.		
2.Recommended manual soldering	300±10℃ for 3 seconds		
3.Recommended screen thickness and open area ratio	Thickness: 0.15mm Open area ratio: 100%		
4.Board warpage	Maximum of 0.03mm at the connector center, with both ends of the		
5.Cleaning conditions	connector as reference points. Refer to "User Guide for Wire-to-Board Connector".		
6.Wire preparation and contact crimping	Refer to "User Guide for Wire to Board Connector".		
	The crimp contact termination must be performed using specified tools.		
	All dimensions and crimp conditions are listed in applicable Crimp Condition Table and Crimping Quality Standards Manual.		
7.Crimped contact extraction	■ Insert the contact retention tool in the insulator body and carefully lift the		
	molded-in retention tab while pulling on the wire at the same time (Fig. 1). Do not deflect the molded-in retention tab more than is needed to release		
	the contact. The tab should return to its initial position after the contact is		
	removed. Note: If the tab is not returning to it's initial position carefully push I back		
	before inserting the crimped contact.		
	Permanent breakage of the molded-in retention tab will require		
	replacement of the entire plug. Contact extraction tool		
	Plug Molded-in contact retention tab		
	Pull-out		
	Contact Figure 1. Contact Extraction		
	rigure 1. Contact Extraction		

8.Crimped contact insertion	Contact must be inserted horizontally oriented as shown on Fig. 2 Do NOT attempt to insert crimped contact in any other direction. Horizontal insertion! MDF76-30P-1C Insert MDF76-2836PCFA(41) Crimped contact Figure 2. Crimped Contact Insertion
9.Connector mating / unmating	Mating / unmating of the connectors should be done in the direction parallel to the receptacle's mounting surface. Do not attempt to mate/unmate in any other direction. Note: The connectors will self-guide themselves within the 20° angle, as shown in Fig. 3. MDF76 # W-30S-1H(***) Receptacle PCB Figure 3. Angular mating / unmating
10.Precautions	Do not mate / unmate the connectors when the receptacle is NOT mounted on the PC board. Differences in color shade of molded components will not affect form, fit or function. Contact HRS if additional information is required.

MEMO:

MEMO:

MEMO:

HIROSE ELECTRIC CO.,LTD.

2-6-3,Nakagawa Chuoh,Tsuzuki-Ku,Yokohama-Shi 224-8540,JAPAN https://www.hirose.com/